

### 2.8X1.0mm RIGHT ANGLE SMD CHIP LED LAMP



ATTENTION

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

APKA2810TGC

**GREEN** 

#### **Features**

- •2.8mmX1.0mm RIGHT ANGLE SMT LED, 1.2mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- ●PACKAGE: 2000PCS/REEL.
- ●RoHS COMPLIANT.

#### **Description**

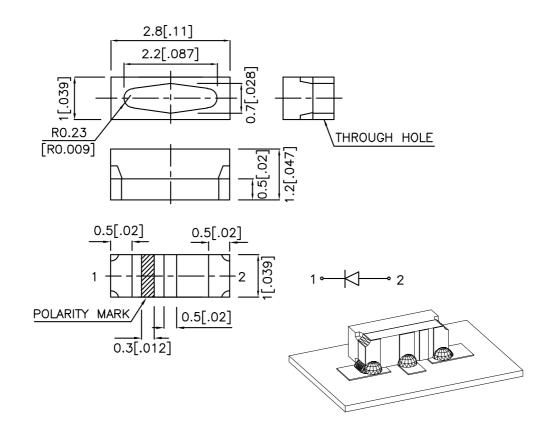
The Green source color devices are made with InGaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

### **Package Dimensions**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(\pm 0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

 SPEC NO: DSAD1134
 REV NO: V.3
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 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: W.J.ZHU
 ERP:1204000371

### **Selection Guide**

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA Min. Typ.		Viewing Angle
					201/2
APKA2810TGC	GREEN (InGaN)	WATER CLEAR	70	150	90°

### Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	500		nm	IF=20mA
λD	Dominant Wavelength	Green	505		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	56		pF	VF=0V;f=1MHz
VF	Forward Voltage	Green	3.6	4.4	V	IF=20mA
lr	Reverse Current	Green		10	uA	VR = 5V

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Green	Units
Power dissipation	110	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature -40°C To +85°C		

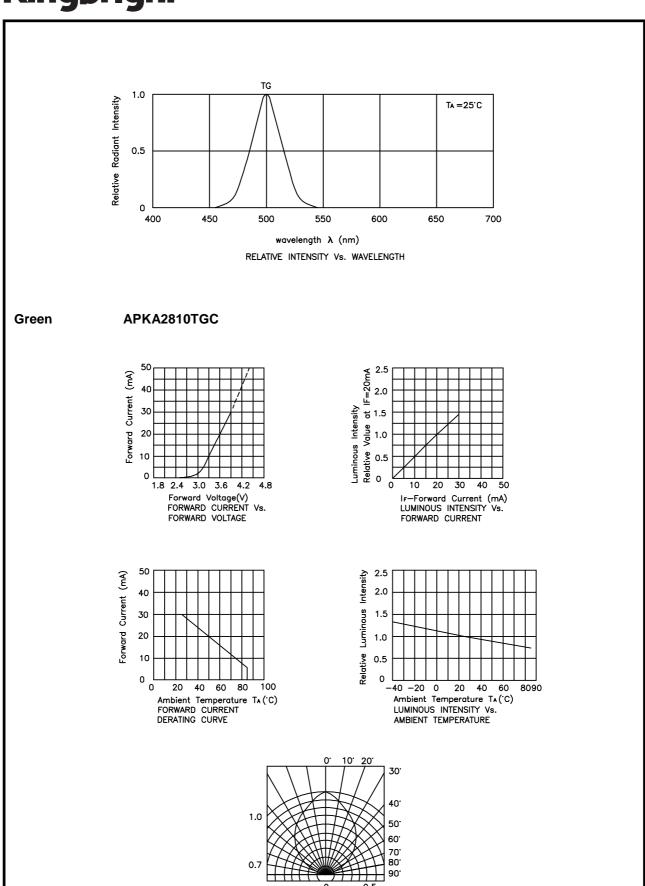
#### Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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<sup>1.</sup>  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.



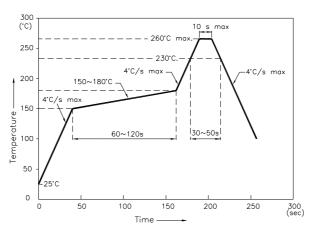
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SPATIAL DISTRIBUTION

#### APKA2810TGC

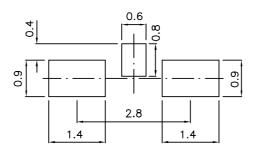
Reflow Soldering Profile For Lead-free SMT Process.



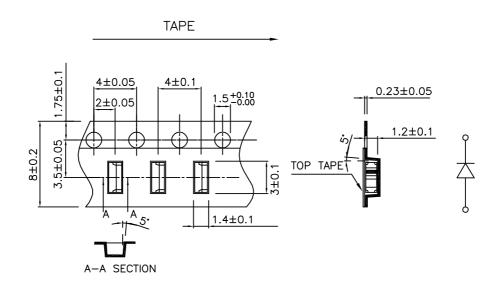
NOTES:

- 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it  $% \left( 1\right) =\left( 1\right) +\left( 1\right) =\left( 1\right) =\left$ to high temperature.
- 3. Number of reflow process shall be 2 times or less.

#### **Recommended Soldering Pattern** (Units:mm)

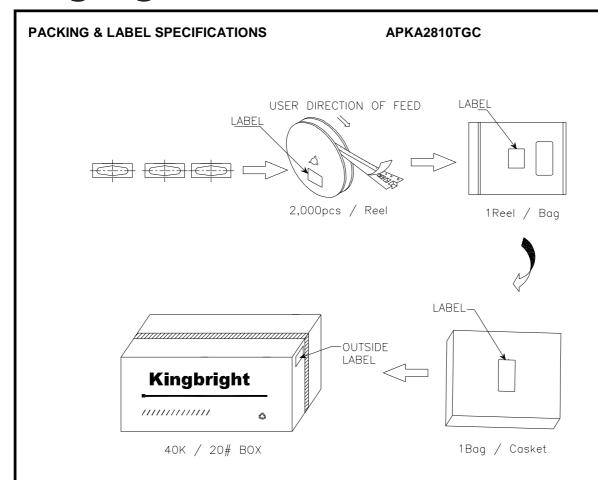


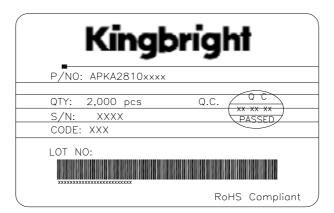
#### **Tape Specifications** (Units: mm)



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#### Remarks

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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